

## C0603C302J3GACTU

Aliases (C0603C302J3GAC7867) SMD Comm C0G, Ceramic, 3,000 pF, 5%, 25 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603, 0.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	3.7 mg
Shelf Life	78 Weeks
MSL	1

imensions		s
hip Size	0603	C
	1.6mm +/-0.15mm	M
1	0.8mm +/-0.15mm	Т
	0.8mm +/-0.07mm	٧
	0.5mm MIN	C
	0.35mm +/-0.15mm	Т
		т

## Packaging Specifications

Di Ch L W T S B

Packaging	T&R, 180mm, Paper Tape
Packaging Quantity	4000

Specifications	
Capacitance	3,000 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	5%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1%1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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